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| SERIAL NUMBER 10/616,097 | FILING DATE 07/08/2003 RULE | CLASS 205 | GROUP ART UNIT 1753 | ATTORNEY DOCKET NO. AMAT/8241/CMP/ECP/RKK |
| APPLICANTS Zhi-Wen Sun, San Jose, CA; Renren He, Sunnyvale, CA; You Wang, Cupertino, CA; Michael X. Yang, Palo Alto, CA; | | | | |
| ** CONTINUING DATA ***** <i>None. W</i> | | | | |
| ** FOREIGN APPLICATIONS ***** <i>None. W</i> | | | | |
| IF REQUIRED, FOREIGN FILING LICENSE GRANTED ** 10/14/2003 | | | | |
| Foreign Priority claimed 35 USC 119 (a-d) conditions met Verified and Acknowledged | <input type="checkbox"/> yes <input checked="" type="checkbox"/> no <i>Allowance 5/31/05</i> Examiner's Signature <i>[Signature]</i> Initials <i>[Initials]</i> | STATE OR COUNTRY CA | SHEETS DRAWING 2 | TOTAL CLAIMS 33 |
| INDEPENDENT CLAIMS 3 | | | | |
| ADDRESS 44257 MOSER, PATTERSON & SHERIDAN, LLP APPLIED MATERIALS, INC. 3040 POST OAK BOULEVARD, SUITE 1500 HOUSTON , TX 77056 | | | | |
| TITLE Multiple-step electrodeposition process for direct copper plating on barrier metals | | | | |
| FILING FEE RECEIVED | FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following: | <input type="checkbox"/> All Fees <input type="checkbox"/> 1.16 Fees (Filing) <input type="checkbox"/> 1.17 Fees (Processing Ext. of time) | | |